# Ultra Field Stop IGBT, 1200 V, 75 A

#### **General Description**

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Ultra Field Stop Trench construction, and provides superior performance in demanding switching applications, offering both low on-state voltage and minimal switching loss. The IGBT is well suited for UPS and solar applications. Incorporated into the device is a soft and fast co-packaged free wheeling diode with a low forward voltage.

#### Features

- Extremely Efficient Trench with Field Stop Technology
- Maximum Junction Temperature:  $T_J = 175^{\circ}C$
- Low Saturation Voltage:  $V_{CE(sat)} = 1.7 \text{ V}$  (Typ.) @  $I_C = 75 \text{ A}$
- 100% of the Parts Tested for  $I_{LM}(1)$
- Soft Fast Reverse Recovery Diode
- Optimized for High Speed Switching
- RoHS Compliant

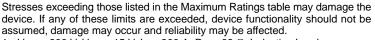
#### Applications

• Solar Inverter, UPS

#### ABSOLUTE MAXIMUM RATINGS

 $(T_J = 25^{\circ}C \text{ unless otherwise stated})$ 

Symbol	Parameter	Value	Unit
V <sub>CES</sub>	Collector to Emitter Voltage	1200	V
V <sub>GES</sub>	Gate to Emitter Voltage	±20	V
	Transient Gate to Emitter Voltage	±30	V
Ι <sub>C</sub>	Collector Current @ $T_C = 25^{\circ}C$	150	А
	Collector Current @ T <sub>C</sub> = 100°C	75	А
I <sub>LM</sub> (1)	Pulsed Collector Current @ $T_C = 25^{\circ}C$	300	А
I <sub>CM</sub> (2)	Pulsed Collector Current	300	А
١ <sub>F</sub>	Diode Forward Current @ $T_C = 25^{\circ}C$	150	А
	Diode Forward Current @ $T_C = 100^{\circ}C$	75	А
I <sub>FM</sub>	Pulsed Diode Max. Forward Current	300	А
P <sub>D</sub>	Maximum Power Dissipation @ T <sub>C</sub> = 25°C @ T <sub>C</sub> = 100°C	790 395	W
Τ <sub>J</sub>	Operating Junction Temperature	-55 to +175	°C
T <sub>stg</sub>	Storage Temperature Range	-55 to +175	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 s	300	°C



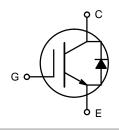
1. V\_{CC} = 800 V, V\_{GE} = 15 V, I\_C = 300 A, R\_G = 68  $\Omega$ , Inductive Load.

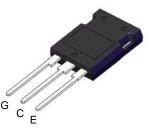
2. Repetitive rating: Pulse width limited by max. junction temperature.



## **ON Semiconductor®**

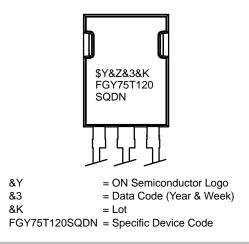
www.onsemi.com





TO-247-3LD CASE 340CD

#### MARKING DIAGRAM



#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 3 of this data sheet.

#### THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case, Max.	0.19	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case, Max.	0.38	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient, Max.	40	°C/W

### **ELECTRICAL CHARACTERISTICS OF THE IGBT** ( $T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Мах	Unit
OFF CHARAC	CTERISTICS					
BV <sub>CES</sub>	Collector to Emitter Breakdown Voltage	$V_{GE}$ = 0 V, I <sub>C</sub> = 500 $\mu$ A	1200	-	-	V
ICES	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	400	μΑ
I <sub>GES</sub>	G–E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±200	nA
ON CHARAC	TERISTICS					
V <sub>GE(th)</sub>	G–E Threshold Voltage	$I_C = 400 \ \mu A, \ V_{CE} = V_{GE}$	4.5	5.5	6.5	V
V <sub>CE(sat)</sub>	Collector to Emitter Saturation	I <sub>C</sub> = 75 A, V <sub>GE</sub> = 15 V	-	1.7	1.95	V
	Voltage	$I_{C}$ = 75 A, $V_{GE}$ = 15 V, $T_{C}$ = 175°C	-	2.3	-	V
DYNAMIC CH	ARACTERISTICS					
Cies	Input Capacitance	$V_{CE} = 20 V_{,} V_{GE} = 0 V_{,} f = 1 MHz$	_	9060	-	pF
Coes	Output Capacitance		-	242	-	pF
C <sub>res</sub>	Reverse Transfer Capacitance		-	137	-	pF
SWITCHING (	CHARACTERISTICS					
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{CC} = 600 \text{ V}, I_C = 75 \text{ A},$	_	64	-	ns
t <sub>r</sub>	Rise Time	= R <sub>G</sub> = 10 Ω, V <sub>GE</sub> = 15 V, Inductive Load, T <sub>C</sub> = 25°C	-	96	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		-	332	-	ns
t <sub>f</sub>	Fall Time		-	28	-	ns
Eon	Turn-On Switching Loss	-	-	6.25	-	mJ
E <sub>off</sub>	Turn-Off Switching Loss	-	-	1.96	-	mJ
E <sub>ts</sub>	Total Switching Loss		-	8.21	-	mJ
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{CC} = 600 \text{ V}, I_C = 75 \text{ A},$	-	56	-	ns
t <sub>r</sub>	Rise Time	$R_G = 10 \Omega$ , $V_{GE} = 15 V$ , Inductive Load, $T_C = 175$ °C	-	80	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		-	364	-	ns
t <sub>f</sub>	Fall Time		-	88	-	ns
Eon	Turn-On Switching Loss		-	8.67	-	mJ
E <sub>off</sub>	Turn-Off Switching Loss		_	3.2	-	mJ
E <sub>ts</sub>	Total Switching Loss	1	-	11.87	-	mJ
Qg	Total Gate Charge	$V_{CE} = 600 \text{ V}, I_C = 75 \text{ A},$	-	399	-	nC
Q <sub>ge</sub>	Gate to Emitter Charge	V <sub>GE</sub> = 15 V	_	74	-	nC
Q <sub>gc</sub>	Gate to Collector Charge		-	192	-	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Symbol	Parameter	Test Conditions		Min	Тур	Мах	Unit
$V_{FM}$	Diode Forward Voltage	I <sub>F</sub> = 75 A	$T_C = 25^{\circ}C$	-	3.4	4	V
			T <sub>C</sub> = 175°C	-	2.7	-	
t <sub>rr</sub>	t <sub>rr</sub> Diode Reverse Recovery Time	$V_{R} = 600 \text{ V}, I_{F} = 75 \text{ A},$	$T_C = 25^{\circ}C$	-	99	-	ns
		Time $dI_F/dt = 500 \text{ A}/\mu \text{s}$	T <sub>C</sub> = 175°C	-	329	-	
Q <sub>rr</sub>		T <sub>C</sub>	$T_C = 25^{\circ}C$	-	1001	-	nC
	Charge		T <sub>C</sub> = 175°C	-	5696	-	
Irrm Diode Reverse Recov Current	Diode Reverse Recovery	ry	$T_C = 25^{\circ}C$	-	20	-	А
	Current		T <sub>C</sub> = 175°C	-	34	_	

#### **ELECTRICAL CHARACTERISTICS OF THE DIODE** ( $T_C = 25^{\circ}C$ unless otherwise noted)

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Shipping
FGY75T120SQDN	FGY75T120SQDN	TO-247-3LD (Pb-Free)	30 / Tube

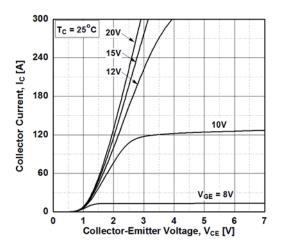


Figure 1. Typical Output Characteristics (25°C)

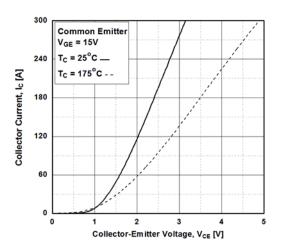


Figure 3. Typical Saturation Voltage Characteristics

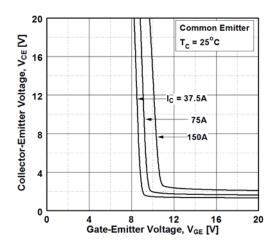


Figure 5. Saturation Voltage vs. V<sub>GE</sub> (25°C)

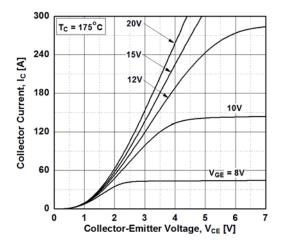


Figure 2. Typical Output Characteristics (175°C)

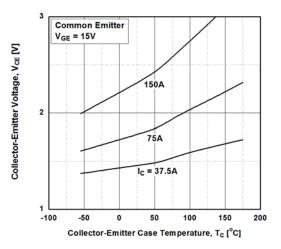


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level

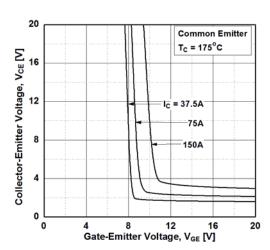
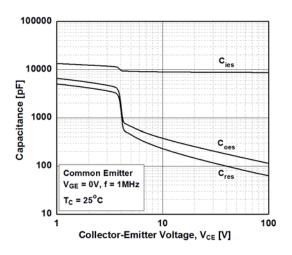
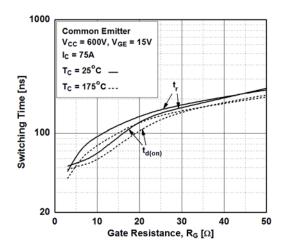


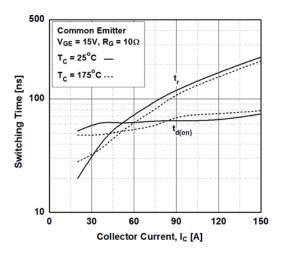
Figure 6. Saturation Voltage vs. V<sub>GE</sub> (175°C)

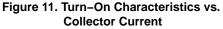












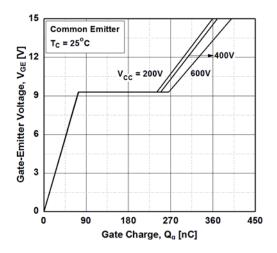


Figure 8. Gate Charge Characteristics

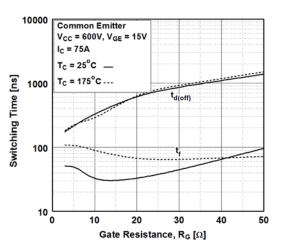
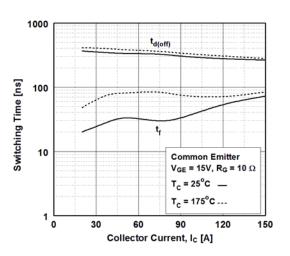
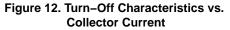


Figure 10. Turn–Off Characteristics vs. Gate Resistance





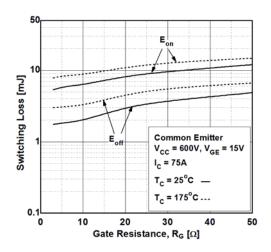


Figure 13. Switching Loss vs. Gate Resistance

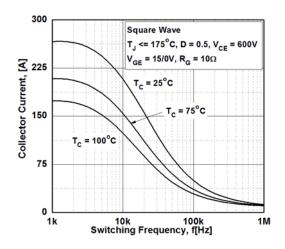
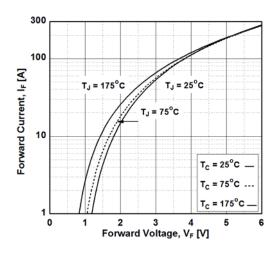


Figure 15. Load Current vs. Frequency



**Figure 17. Forward Characteristics** 

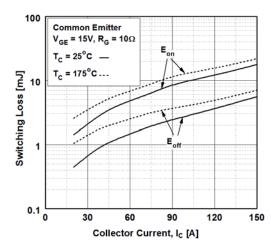
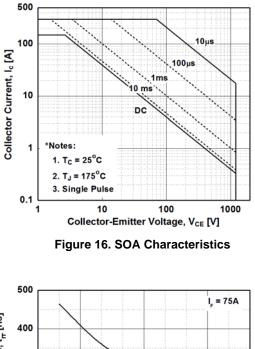


Figure 14. Switching Loss vs. Collector Current



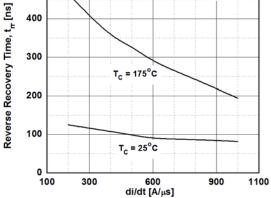
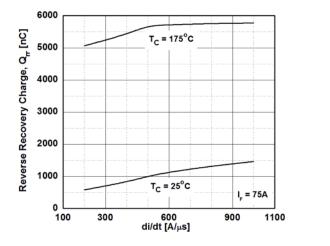


Figure 18. Reverse Recovery Time vs. di<sub>F</sub>/dt



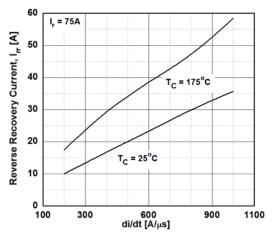


Figure 19. Reverse Recovery Charge vs. di<sub>F</sub>/dt

Figure 20. Reverse Recovery Current vs. di<sub>F</sub>/dt

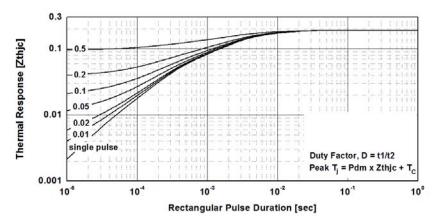


Figure 21. Transient Thermal Impedance of IGBT

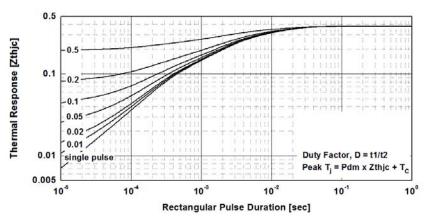


Figure 22. Transient Thermal Impedance of Diode

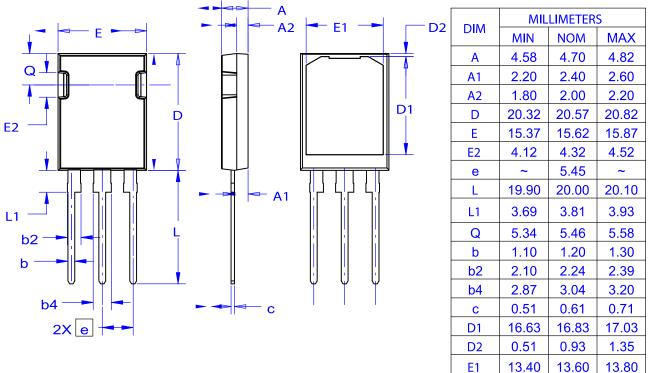
#### PACKAGE DIMENSIONS

TO-247-3LD CASE 340CD **ISSUE A** 

NOTES:

- A. THIS PACKAGE DOES NOT CONFORM TO ANY STANDARDS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS. C. DIMENSIONS ARE EXCLUSIVE OF BURRS
- MOLD FLASH AND TIE BAR PROTRUSIONS. D. DIMENSION AND TOLERANCE AS PER ASME

Y14.5-2009.



ON Semiconductor and 💷 are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <a href="http://www.onsemi.com/site/pdl/Patent-Marking.pdf">www.onsemi.com/site/pdl/Patent-Marking.pdf</a>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typical" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

Phone: 421 33 790 2910

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support:

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative